

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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amdt  
12-5-00

In re application of

Kazuto NISHIDA

Serial No. 09/331,763

Filed June 25, 1999



Docket No.00177/526327

Group Art Unit 3729

Examiner R. Sands

METHOD AND APPARATUS FOR  
MOUNTING ELECTRONIC COMPONENT  
ON CIRCUIT BOARD

RECEIVED  
DEC - 1 2000  
TECHNOLOGY CENTER 3700

AMENDMENT

Assistant Commissioner for Patents,  
Washington, D.C.

Sir:

In response to the Office Action of May 24, 2000, the period for response to which having been extended by three months to November 24, 2000, please amend the above-identified U.S. Patent application as follows:

IN THE ABSTRACT

Please amend the abstract as follows:

Line 3, after "chip" delete "1" and after "board" delete "4".

Line 4, after "bumps" delete "3" and change "2 on" to --of--.

Line 7, after "resin" delete "6".

Line 10, after "head" delete "8".

THE COMMISSIONER IS AUTHORIZED  
TO CHARGE ANY DEFICIENCY IN THE  
FEES FOR THIS PAPER TO DEPOSIT  
ACCOUNT NO. 23-0975